

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KEIICHI TAKAHASHI	09/18/2020
KAZUTO ARAI	09/18/2020
RECEIVING PARTY DATA	
Name:	NAKAMURA MFG. CO., LTD.
Street Address:	493-1 MIKKAMACHI, MINOWA-MACHI, KAMIINA-GUN
City:	NAGANO
State/Country:	JAPAN
Postal Code:	399-4603
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17061467
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	4592-133
NAME OF SUBMITTER:	BENJAMIN J. HAUPTMAN
SIGNATURE:	/Benjamin J. Hauptman/
DATE SIGNED:	10/02/2020
Total Attachments: 1	
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ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Keiichi TAKAHASHI
- 2) Kazuto ARAI

who has made a certain new and useful invention, hereby sells, assigns and transfers unto Nakamura Mfg. Co., Ltd. having a place of business at 493-1 Mikkamachi, Minowa-machi, Kamiina-gun, Nagano 399-4603 JAPAN, its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled:

METHOD OF MANUFACTURING HEAT SINK AND HEAT SINK

- (a) for which an application for United States Letters Patent was filed on _____, and identified by United States Patent Application No. _____; or
- (b) for which an application for United States Letters Patent was executed on _____.

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Keiichi Takahashi
 Name: Keiichi TAKAHASHI

September 18, 2020
 Date

2) Kazuto Arai
 Name: Kazuto ARAI

September 18, 2020
 Date